

100V Normally Closed (2-Form-B) Solid State Relay

General Features

- Low-level off State Leakage Current
- No Moving Parts
- 1500 Vrms Input/Output Isolation
- Fast Switching Speed
- Highly Efficient GaAlAs Infrared LED and Reliability MOSFETs

$\mathbf{V}_{\mathbf{OFF}}$	I_{ON}	R _{ON(TYP.)}
100V	300mA	3Ω

Applications

- Telecommunications
- I/O Subsystems
- **Industrial Control**
- Security
- Aerospace
- **Electronic Switching**

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2 o —		—o 7	THE STATE OF THE S
3 o —		-• 6	(Unit: mm) 1,2. LED Anode 3,4. LED Cathode
4 o —		—0 5	5,6. Drain (MOSFET) 7,8. Drain (MOSFET)

Ordering Information

Part Number	Package	Marking	Packing quantity
OPW415	DIP-4	OPW415	2000pcs/REEL

Absolute Maximum Ratings

T_a=25°C unless otherwise specified

	Item	Symbol	Note	Value	Unit
	LED Forward Current	I_{F}		50	mA
Input	LED Pulse Forward Current	I_{FP}	f=100Hz, duty=1%	1000	mA
	LED Reverse Voltage	V_R		5	V
	Diode Power Dissipation	P _D		75	mW
	LED Junction Temperature	T_{j}		125	°C
	Load Voltage	V _{OFF}	AC Peak or DC	100	V
	On-state Current	I _{ON}		300	mA
Output	On-state Peak Current	I _{ONP}	100ms(1 pulse)	0.3	A
	Output Power Dissipation	Po		300	mW
	Junction Temperature	T_{j}		125	°C
Total Power Dissipation		P _T		350	mW
Storage	Temperature	T_{stg}		-40 to 100	°C
Operatin	g Temperature	$T_{ m opr}$		-40 to 85	°C
Lead So	ldering Temperature	$T_{\rm sol}$	10 sec max.	260	°C
Isolation Voltage [3]		BV _{IO}	AC, RH≤60%, 60s	1500	Vrms

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.



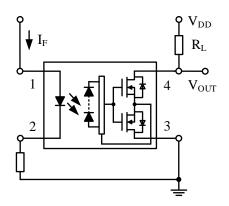
Electrical Characteristics

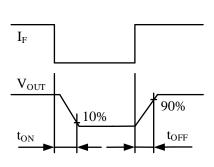
 $T_a=25$ °C unless otherwise specified

Item		Symbol	Min.	Тур.	Max.	Unit	Test Conditions	
	LED Forward Voltage	V_{F}		1.3	1.5	V	I _F =10mA	
	LED Reverse Current	I_R			5.0	μΑ	V _R =5V	
Input	Trigger LED Current	I_{FC}		0.2	2.0	mA	I _{OFF} =100uA	
	Return LED Current	I_{FT}	0.1	0.2		mA	I _{ON} =200mA	
	Return LED Voltage	V_{FC}	0.5			V	I _{OFF} =200uA	
	On-Resistance [2]	Ron		3	6	Ω	I _{ON} =200mA	
Output	Off-State Leakage Current	I _{OFF}			1.0	μΑ	V _{OFF} =100V, I _F =5mA	
	Output Capacitance	C_{OUT}	-1-	45		pF	V _{OFF} =0V, f=1MHz I _F =5mA	
Transmission	Turn-on Time [3]	Ton	1	1	0.5	ms	I _F =5mA, I _{ON} =200mA	
Transmission	Turn-off Time [3]	T_{OFF}			0.5	ms		
	Capacitance Input to Output	C_{IO}		0.6		pF	V _{IO} =0V, f=1MHz	
Coupled	Isolation Resistance	R _{IO}	10 ¹⁰	-		Ω	DC=500V	
	Isolation Voltage	BV_{IO}	1500			V	AC, 60s	

NOTE:

- [1] LED pins are shorted together. Detector pins are also shorted together.
- [2] Measurement Taken within 1 Second of On-time.
- [3] Switching Time Test Circuit.







Package Dimensions

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